

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	IPZ40N04S5L-4R8	**Issued**	08. April 2022
MA#	MA005709720		
Package	PG-TSDSON-8-32	**Weight***	35.35 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	0.336	0.95	0.95	9491	9491
leadframe	inorganic material	phosphorus	7723-14-0	0.003	0.01		88	
	non noble metal	zinc	7440-66-6	0.012	0.04		352	
	non noble metal	iron	7439-89-6	0.249	0.70		7038	
	non noble metal	copper	7440-50-8	10.102	28.58	29.33	285758	293236
wire	noble metal	gold	7440-57-5	0.030	0.09	0.09	861	861
encapsulation	organic material	carbon black	1333-86-4	0.037	0.11		1054	
	plastics	epoxy resin	-	1.918	5.43		54255	
	inorganic material	silicondioxide	60676-86-0	16.667	47.12	52.66	471442	526751
leadfinish	non noble metal	tin	7440-31-5	0.400	1.13	1.13	11322	11322
plating	noble metal	silver	7440-22-4	0.086	0.24	0.24	2422	2422
solder	non noble metal	tin	7440-31-5	0.010	0.03		294	
	noble metal	silver	7440-22-4	0.013	0.04		367	
	non noble metal	lead	7439-92-1	0.496	1.40	1.47	14035	14696
heat sink clip	inorganic material	phosphorus	7723-14-0	0.001			26	
	non noble metal	zinc	7440-66-6	0.004	0.01		103	
	non noble metal	iron	7439-89-6	0.073	0.21		2060	
	non noble metal	copper	7440-50-8	2.958	8.37	8.59	83660	85849
heatspreader	inorganic material	phosphorus	7723-14-0	0.001			17	
	non noble metal	zinc	7440-66-6	0.002	0.01		66	
	non noble metal	iron	7439-89-6	0.047	0.13		1329	
	non noble metal	copper	7440-50-8	1.908	5.40	5.54	53960	55372
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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